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(54) **Title:** BANK STRUCTURES FOR ORGANIC ELECTRONIC DEVICES

(57) **Abstract:** The invention relates to the use of polycycloolefinic polymers as structure defining material in organic electronic devices, for example in separators, insulating structures or bank structures of such devices, and further relates to organic electronic devices comprising such polycycloolefinic polymer bank structures, and to processes for preparing such polycycloolefinic polymer bank structures and organic electronic devices.

